

## Schottky Barrier Diode DB2460200L

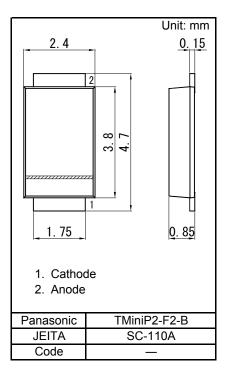
DB2460200L Silicon epitaxial planar type

#### For rectification

- Features
- Low forward voltage VF
- Forward current (Average) IF(AV) = 3 A rectification is possible
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: A9

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



# t Internal Connection

#### ■ Absolute Maximum Ratings Ta = 25 °C

	0		
Parameter	Symbol	Rating	Unit
Reverse voltage	VR	60	V
Maximum peak reverse voltage	VRM	60	V
Forward current <sup>*1</sup>	IF	3.0	А
Non-repetitive peak forward surge current *2	IFSM	50	А
Junction temperature	Tj	125	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +125	°C

Note: \*1 With a Alumina PC board (Board size: 5 cm× 5 cm)

\*2 50 Hz sine wave 1 cycle (Non-repetitive peak current)

## Panasonic

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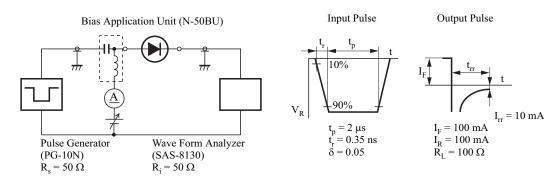
#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 3.0 A			0.6	V
Reverse current	IR	VR = 60 V			150	μA
Terminal capacitance	Ct	VR = 10 V, f = 1 MHz		106		pF
Reverse recovery time *1	trr	IF = IR = 100 mA Irr = 10 mA, RL = 100 Ω		36		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

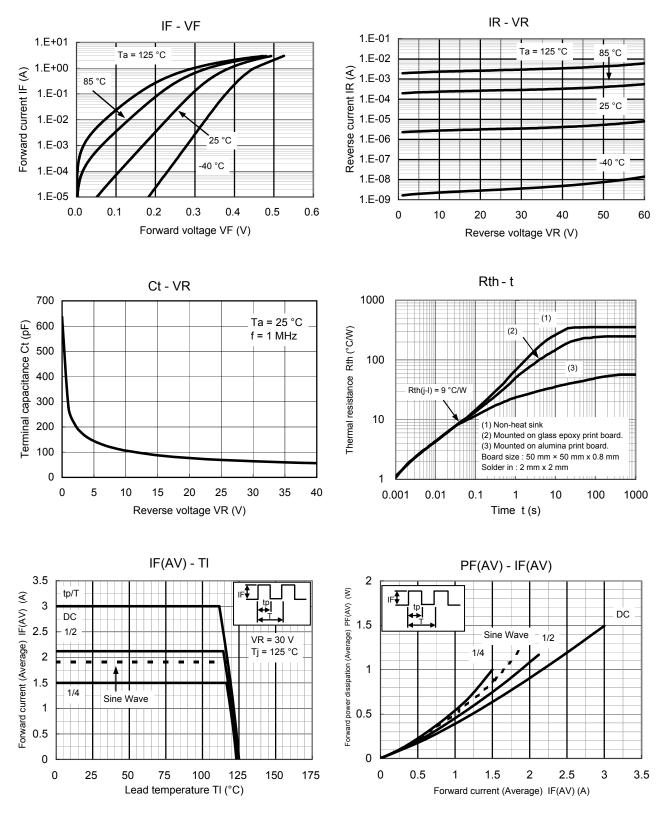
3. \*1 trr test circuit





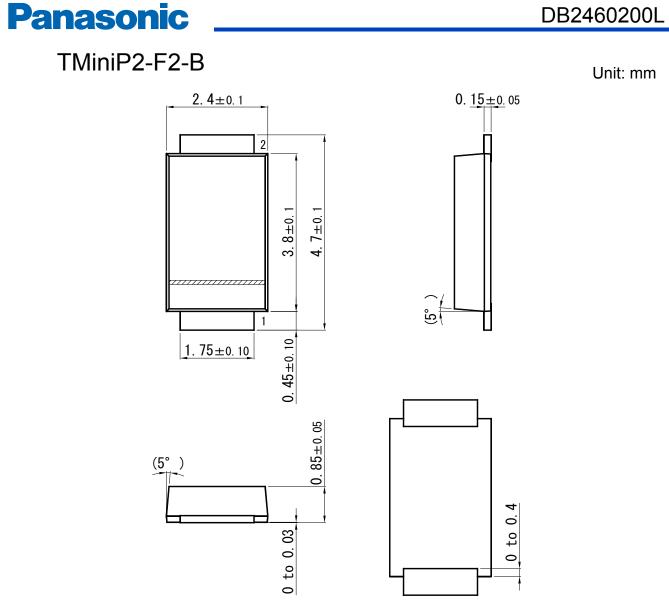
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## Technical Data (reference)

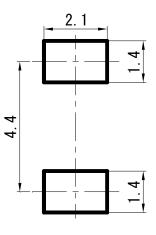


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Established : 2010-10-29 Revised : 2013-04-20







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